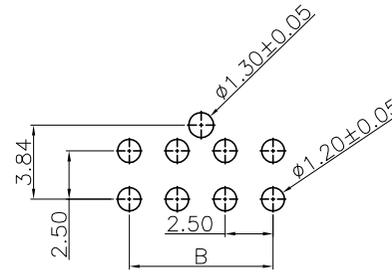
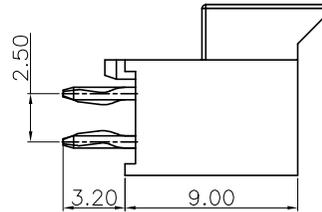
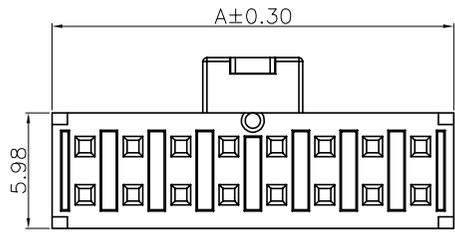


The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements

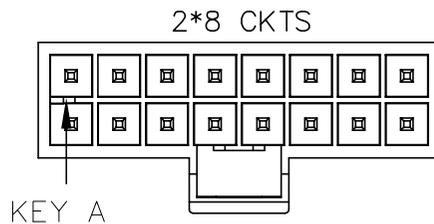
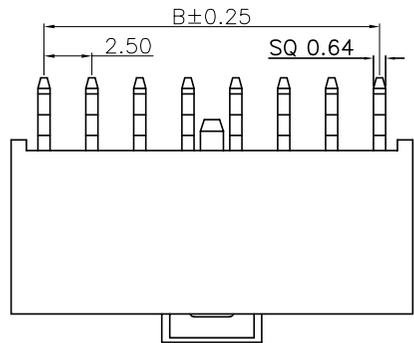
RoHS+HF



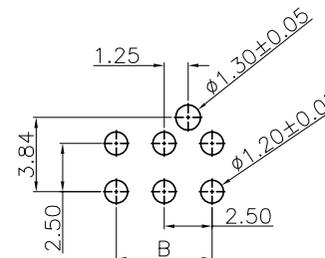
PCB Layout

NOTE:

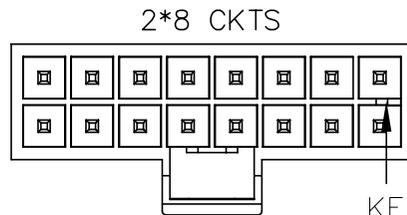
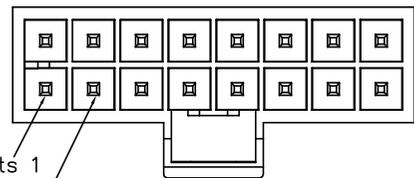
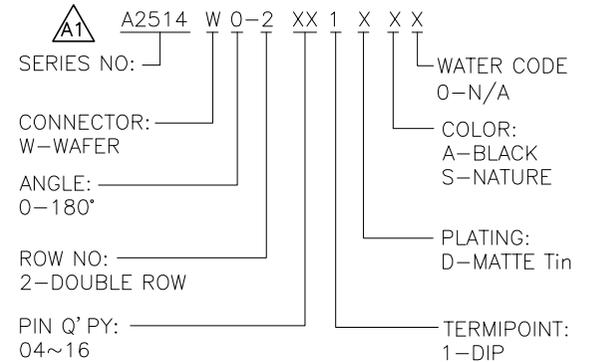
- 1.MATERIAL SPECIFICATION:
 - 1-1.HOUSING: LCP,UL94V-0
 - 1-2.CONTACTS: BRASS
- 2.PLATING SPECIFICATION:
 - 2-1.CONTACTS: TIN/GOLD FLASH PLATED OVER ALL.
- 3.ELECTRICAL PERFORMANCE:
 - 3-1.CURRENT RATING: 8A AC/DC
 - 3-2.CONTACT RESISTANCE: 20 mΩ MAX
 - 3-3.INSULATION RESISTANCE: 1000MΩ Min
 - 3-4.DIELECTRIC WITHSTANDING : 1500V
- 4.ENVIRONMENTAL PERFORMANCE:
 - 4-1.OPERATING TEMPERATURE: -40°C~+105°C.
- 5.PACKAGE SPEC : TRAY
- 6.P/N:



Color: Black



2*3 2*5 2*7 PCB Layout



Color: Natural

Dimensional infotmation(mm)

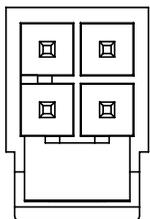
Circuits	Dimensions(mm)		Circuits	Dimensions(mm)	
	A	B		A	B
2*02	5.94	2.50	2*06	15.94	12.50
2*03	8.44	5.00	2*07	18.44	15.00
2*04	10.94	7.50	2*08	20.94	17.50
2*05	13.44	10.00			

REV.	REVISION RECORD	DATE	GENERAL TOLERANCES		SCALE:	NAME	DATE	PART.NO:	DWG.NO:	 WanLian Technology Co., Ltd
A0	NEW RELEASE	21.11.17	LINEAR	ANGLES	1:1	Wang_jr	23.09.25	A2514W0-2XX1XXX	ENDE05	
A1	PART NUMBER RENEWAL	23.09.25	0.0±0.35	X'REF±6'	APPROVED	Han_Gao	23.09.25	TITLE:		
			0.00±0.25	X'±3'	DESIGNER	Zijun_Huang	23.09.25	Pitch 2.50mm MX 双排180°带扣带定位柱 DIP型 Wafer		
			UNIT:mm	X'X' ±2'	DRAWN					REV: A1 SHEET: 1/2
			SIZE: A4	0.000±0.10						

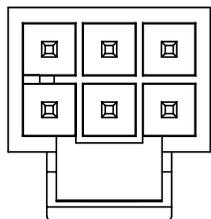
The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements

RoHS+HF

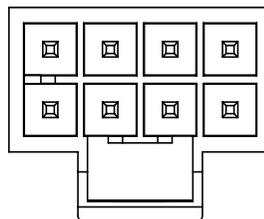
PIN位示意图



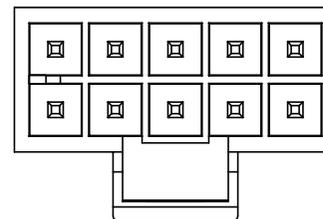
2*2 CKTS



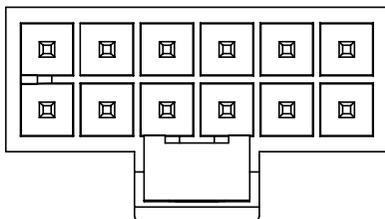
2*3 CKTS



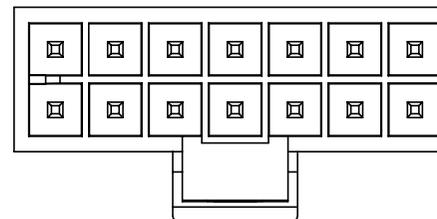
2*4 CKTS



2*5 CKTS



2*6 CKTS



2*7 CKTS

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: A2514W0-2XX1XXX	DWG.NO: ENDE05	 WanLian Technology Co., Ltd	
A0	NEW RELEASE	21.11.17		LINEAR	ANGLES	APPROVED	Wang_jr	23.09.25				
A1	PART NUMBER RENEWAL	23.09.25	UNIT:mm	0.00±0.25	X'±3'	DESIGNER	Han_Gao	23.09.25	TITLE: Pitch 2.50mm MX 双排180°带扣带定位柱 DIP型 Wafer	REV: A1		SHEET: 2/2
			SIZE: A4	0.000±0.10	X'X' ±2'	DRAWN	Zijun_Huang	23.09.25				